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## Product Change Notification - BCD2000006 - JAON-22ZKEM744

	03 Nov 2016								
Product Category:	Micrel								
Notification subject:	CCB 1737.02 Final Notice: Release to production of listed Micrel Power Switch product type								
Notification text:	manufactured with the BCD2 process technology to Microchip Fab. PCN Status: Final Notification								
	Note: This final PCN only pertains to the products listed in this PCN. Additional final PCNs may be issued for this combination of product type and process technology.								
	Microchip Parts Affected: Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CF								
	NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).								
	<b>Description of Change:</b> Release to production of listed Micrel Power Switch product type manufactured with the BCD2 proc technology to Microchip Fab.								
	NOTE: Please review the FAQ linked here for additional information about this change.								
	<b>Pre Change:</b> Fabricated at Micrel fabrication site (San Jose, CA, USA) using 6 inch wafers.								
	Post Change: Fabricated at Microchip fabrication site using 8 inch wafers. Pre and Post Change Summary:								
	Pre and Post Change Summ	ary:							
	Pre and Post Change Summ	ary: Pre Change	Post Change						
	Pre and Post Change Summ	•	Post Change Microchip fabrication site						
		Pre Change Micrel fabrication site							
	Fab Site Wafer Size Impacts to Data Sheet: None Reason for Change:	Pre Change         Micrel fabrication site         (San Jose, CA, USA)         6 inch wafers	Microchip fabrication site						
	Fab Site Wafer Size Impacts to Data Sheet: None Reason for Change: To improve productivity with th	Pre Change         Micrel fabrication site         (San Jose, CA, USA)         6 inch wafers         e closure of the Micrel fab as page	Microchip fabrication site 8 inch wafers						
	Fab Site         Wafer Size         Impacts to Data Sheet:         None         Reason for Change:         To improve productivity with the         Microchip.         Change Implementation State	Pre Change         Micrel fabrication site         (San Jose, CA, USA)         6 inch wafers         e closure of the Micrel fab as pa         us:	Microchip fabrication site 8 inch wafers						

	September 2015			->	February 2016				->	N	love 20		er		December 2016					
Workweek	36	37	38	39	40		05	06	07	80		44	45	46	47	48	49	50	51	52
Initial PCN Issue Date CYER- 31JLEX869	x																			
Qual Report Available JAON- 22ZKEM744										x										
Final PCN Issue Date JAON- 22ZKEM744- BCD2000006												х								
Estimated First Ship Date															s list che			-		

Markings to Distinguish Revised from Unrevised Devices: Traceability code and shipping label see FAQ.

## **Revision History:**

September 1, 2015: Issued initial notification as PCN number CYER-31JLEX869. February 25, 2016: Issued intermediate notification as PCN number JAON-22ZKEM744. Attached the Qualification Report. Revised the estimated first ship date (EFSD) to inform that the EFSD will be revealed in the final PCN. November 3, 2016: Issued final notification as PCN number JAON-22ZKEM744-BCD2000006 for listed Micrel's Power Switch products manufactured with the BCD2 process technology. Provided estimated first ship date (EFSD) for each CPN listed in the attached parts list.

The change described in this PCN does not alter Micrel's or Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachment(s):

PCN\_JAON-22ZKEM744\_Qual Report.pdf PCN\_JAON-22ZKEM744-BCD2000006\_Affected\_CPN.pdf PCN\_JAON-22ZKEM744-BCD2000006\_Affected\_CPN.xls

Please contact your local Microchip sales office with questions or concerns regarding this notification.

## **Terms and Conditions:**

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Affected Catalog Part Numbers (CPN)

PCN_JAON-22ZKEM744-BCD2000006									
CATALOG_PART_NBR	Estimated First Ship Date (EFSD)								
SPN011026G	December 15, 2016								
SPN011026G-TR	December 15, 2016								
MIC2536-2YM	December 15, 2016								
MIC2536-2YM-TR	December 15, 2016								
MIC2536-2YMM	December 15, 2016								
MIC2536-2YMM-TR	December 15, 2016								
MIC2536-1YM	November 17, 2016								
MIC2536-1YM-TR	December 15, 2016								
MIC2536-1YMM	December 15, 2016								
MIC2536-1YMM-TR	December 15, 2016								